



ATTORNEY DOCKET NO. MIT 10282 US

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

INVENTOR(S): Yasushi Enokido

Serial No.: 10/601,272

Filing Date: June 20, 2003

Conf. No. 6440

For: METAL SLURRY FOR ELECTRODE FORMATION AND PRODUCTION METHOD  
OF THE SAME

Examiner:

Art Unit: 1742

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:


INFORMATION DISCLOSURE STATEMENT

The references on attached Form PT0/SB/08A+B which relate to the subject matter of the present invention are being brought to the attention of the Patent and Trademark Office pursuant to 37 CFR 1.56 and 1.98. This statement is being filed before the receipt of a first Office Action on the merits.

Accordingly, applicant(s) believe that no fee or certification is required.

CERTIFICATE OF MAILING UNDER 37 CFR §1.8(a)

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on December 19, 2003.

  
Steven J. Weissburg

U.S. Patent No. 5,204,055, entitled THREE-DIMENSIONAL PRINTING TECHNIQUES, issued April 20, 1993, to Emanuel M. Sachs et al.

Japanese Patent Abstract Document No. 06-218712, published August 9, 1994.

Japanese Patent Abstract Document No. 2002-299833, published October 11, 2002.

SACHS, E., CIMA, M., WILLIAMS, P., BRANCAZIO, D., CORNIE, J., Three Dimensional Printing: Rapid Tooling and Prototypes Directly from a CAD Model, Journal of Engineering for Industry, November 1992, Vol. 114, p. 481-488.

GRAU, J., MOON, J., UHLAND, S., CIMA, M., SACHS, E., High green density ceramic components fabricated by the slurry-based 3DP process, Solid Freeform Fabrication Proceedings, 1997, p. 371-378.

ENOKIDO, Y. (TDK Corporation), Conductor Formation in the Solid Freeform Fabrication Technique, Ceramics 36, 2001, No. 6, p. 421-424 (in Japanese, English Abstract attached).

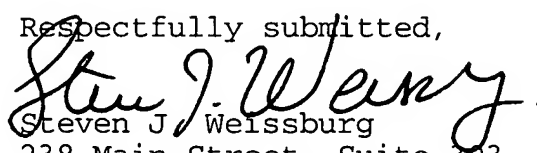
Although this statement includes all the relevant art presently known to the applicants, it should not be interpreted as a representation that an exhaustive search has been

conducted, or that no better art exists or that the items cited herein are admitted to be prior art. Applicants do not admit that all items cited here are from relevant fields. Some were identified by applicants after the invention was made, with the benefit of hindsight. Moreover, Applicants invite the Examiner to make an independent evaluation of the cited art to determine its relevance to the subject matter of the present application.

Applicants are of the opinion that the claims of the present application patentably distinguish over this art or any combination thereof.

The Commissioner is hereby authorized to charge payment of any additional fees associated with this communication or credit any overpayment to Deposit Account No. 23-0833, in the name of the undersigned.

Respectfully submitted,

  
Steven J. Weissburg  
238 Main Street, Suite 303  
Cambridge, MA 02142  
(617) 354-9343

Reg. No. 31,581  
**Cust No. 021403**

December 19, 2003

Blue Mac Storage:Gibraltar clients:Clients:MIT:MIT 3DP All:TDK temporary:MIT

10282 Metal Slurry:IDS 10282





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PTO/SB/08B

<b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b> <i>(use as many sheets as necessary)</i>				<b>Complete if Known</b>	
				Application Number	10/601,272
				Filing Date	June 20, 2003
				First Named Inventor	Enokido
				Group Art Unit	1742
				Examiner Name	
Sheet	2	of	2	Attorney Docket No.	MIT 10282 US

OTHER PRIOR ART - NON PATENT LITERATURE DOCUMENTS			
Examiner Initials	Cite No.	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, symposium, catalog, etc.), date, page(s), volume- issue number(s), publisher, city and/or country where published	T
		SACHS, E., CIMA, M., WILLIAMS, P., BRANCAZIO, D., CORNIE, J.,  Three Dimensional Printing: Rapid Tooling and Prototypes  Directly from a CAD Model, Journal of Engineering for Industry,  November 1992, Vol. 114, p. 481-488.	
		GRAU, J., MOON, J., UHLAND, S., CIMA, M., SACHS, E., High green  density ceramic components fabricated by the slurry-based 3DP  process, Solid Freeform Fabrication Proceedings, 1997, p. 371-  378.	
		ENOKIDO, Y. (TDK Corporation), Conductor Formation in the  Solid Freeform Fabrication Technique, Ceramics 36, 2001, No. 6,  p. 421-424.	

Examiner Signature		Date Considered	
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